

2M150F-050 SIPMOS® FUJI POWER MOS-FET

N-CHANNEL SILICON POWER MOS-FET

MOS-FET MODULE

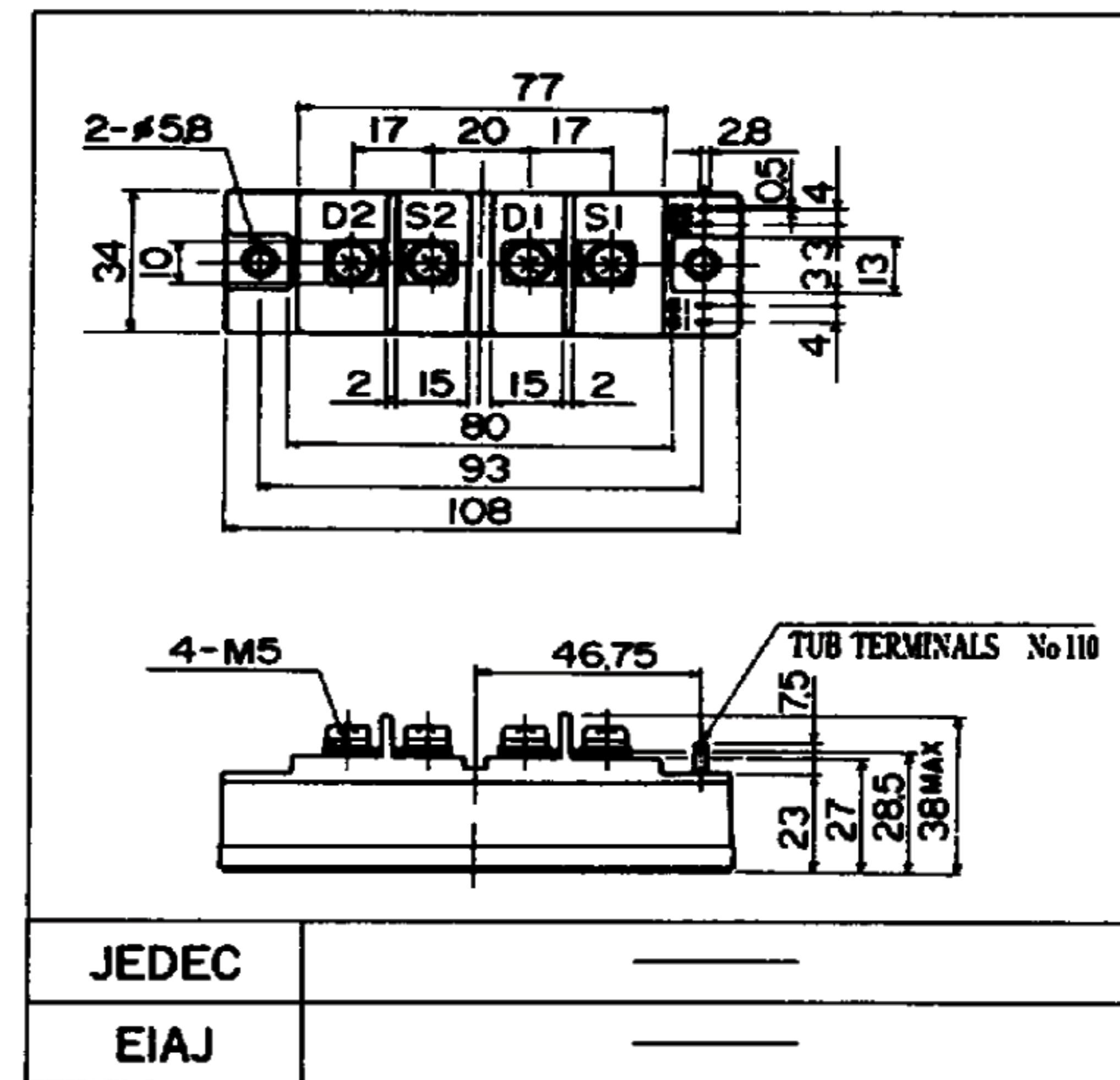
■ Features

- Low on-resistance
- High current
- Insulated to elements and metal base
- Separated two-elements
- Include fast recovery diode

■ Applications

- Inverters
- UPS
- A. C servo motors
- High frequency power supplies

■ Outline Drawings



■ Max. Ratings and Characteristics

● Absolute Maximum Ratings($T_c = 25^\circ\text{C}$)

Items	Symbols	Ratings	Units
Drain-source voltage	V_{DSS}	500	V
Continuous drain current Duty=66%	I_D	50	A
Pulsed drain current	$I_{D(puls)}$	150	A
Continuous reverse drain current	I_{DR}	50	A
Gate-source peak voltage	V_{GSS}	± 20	V
Max. power dissipation	P_D	400	W
Operating and storage temperature range	T_{ch}	150	$^\circ\text{C}$
	T_{stg}	-40 ~ +125	$^\circ\text{C}$
Isolation test voltage	V_{iso}	2500	V

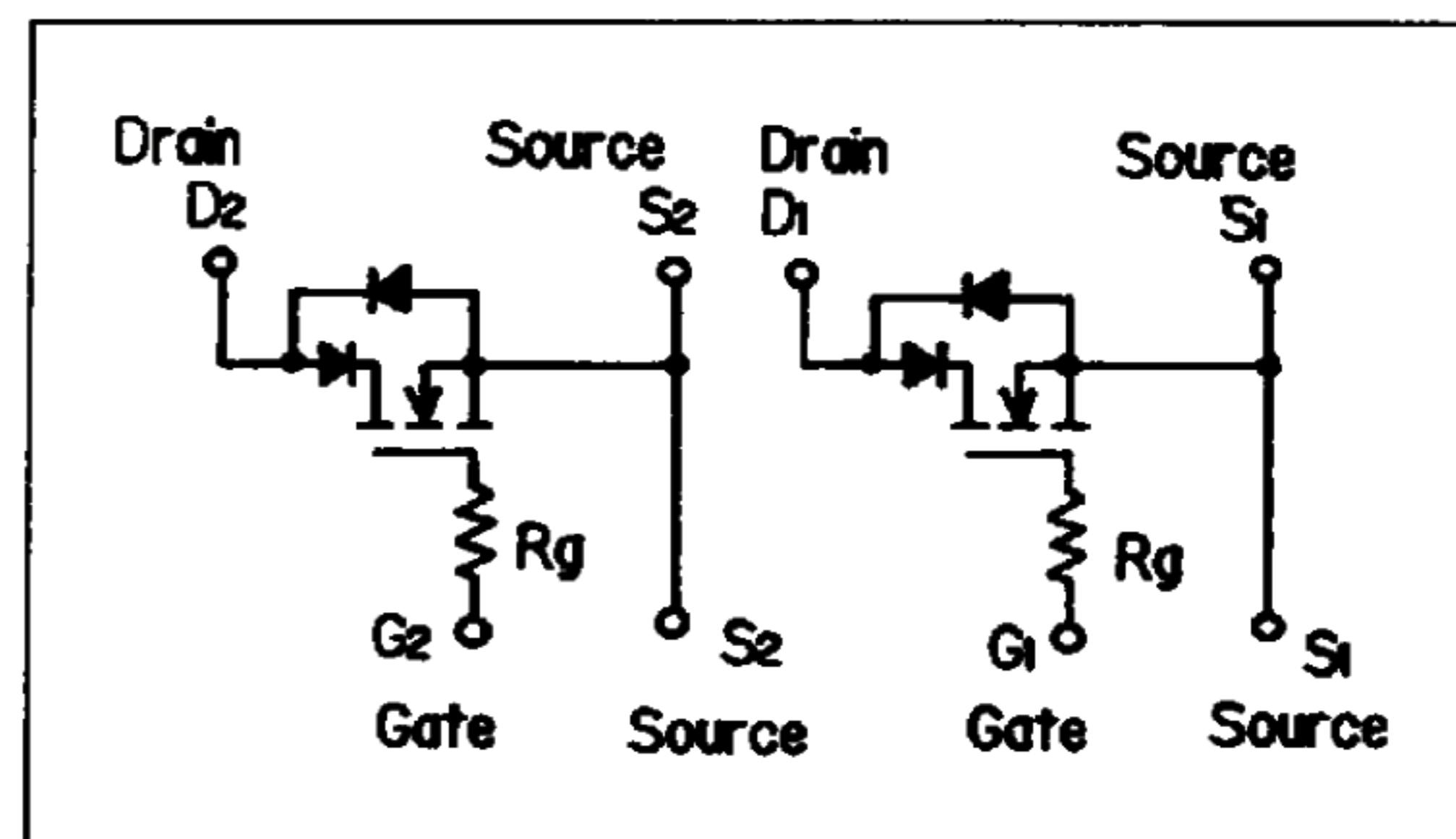
● Electrical Characteristics($T_c = 25^\circ\text{C}$)

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{V}$ $I_D = 1\text{mA}$	500			V
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ $I_D = 10\text{mA}$	2.1	3.0	4.0	V
Zero gate voltage drain current	I_{DSS}	$V_{GS} = 0\text{V}$ $V_{DS} = 500\text{V}$ $T_{ch} = 25^\circ\text{C}$			1.0	mA
Gate-source leakage current	I_{GSS}	$V_{DS} = 0\text{V}$ $V_{GS} = \pm 20\text{V}$			100	nA
Drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 15\text{V}$ $I_D = 25\text{A}$			0.11	Ω
Forward transconductance	g_{fs}	$V_{DS} = 25\text{V}$ $I_D = 25\text{A}$		45		S
Input capacitance	C_{iss}	$V_{GS} = 0\text{V}$		7.8	13	nF
Output capacitance	C_{oss}	$V_{DS} = 25\text{V}$		0.9	1.5	
Reverse transfer capacitance	C_{rss}	$f = 1\text{MHz}$		0.4	0.6	
Switching time ($t_{off} = t_{d(off)} + t_f$)	t_{on}	$V_{CC} = 100\text{V}$ $R_G = 5\Omega$		530	750	ns
	$t_{d(off)}$	$I_D = 25\text{A}$ $P_w = 20\mu\text{s}$		700	1000	
	t_f	$V_{GS} = 15\text{V}$		80	110	
Diode forward on-voltage	V_{SD}	$I_F = 50\text{A}$ $V_{GS} = 0\text{V}$		1.4	1.8	V
Reverse recovery time	t_{rr}	$I_F = 50\text{A}$ $dI/dt = 100\text{A}/\mu\text{s}$ $V_{GS} = 0\text{V}$			150	ns

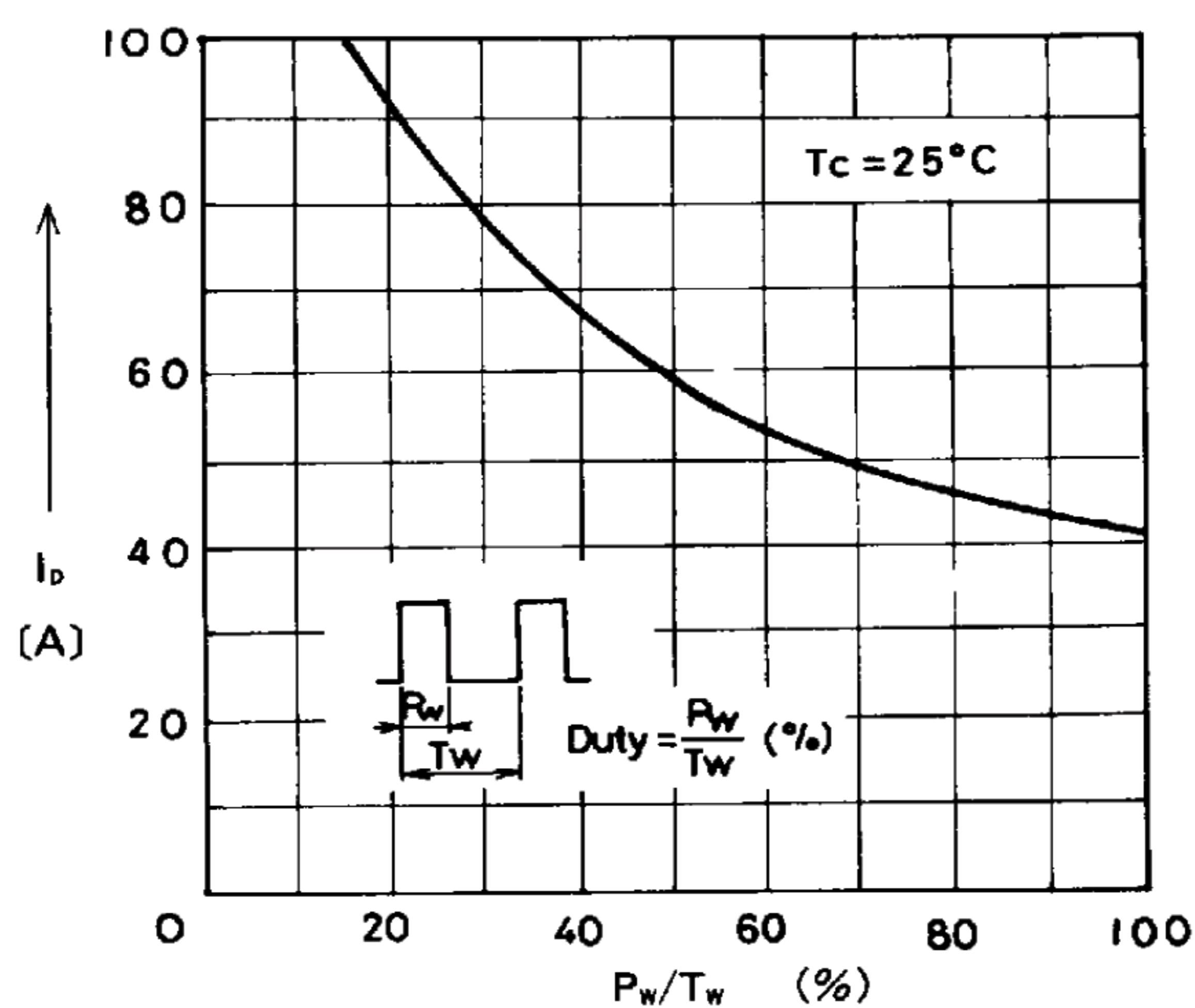
● Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	$R_{th(c-f)}$	case to fin		0.06		$^\circ\text{C/W}$
	$R_{th(ch-c)}$	channel to case			0.312	$^\circ\text{C/W}$

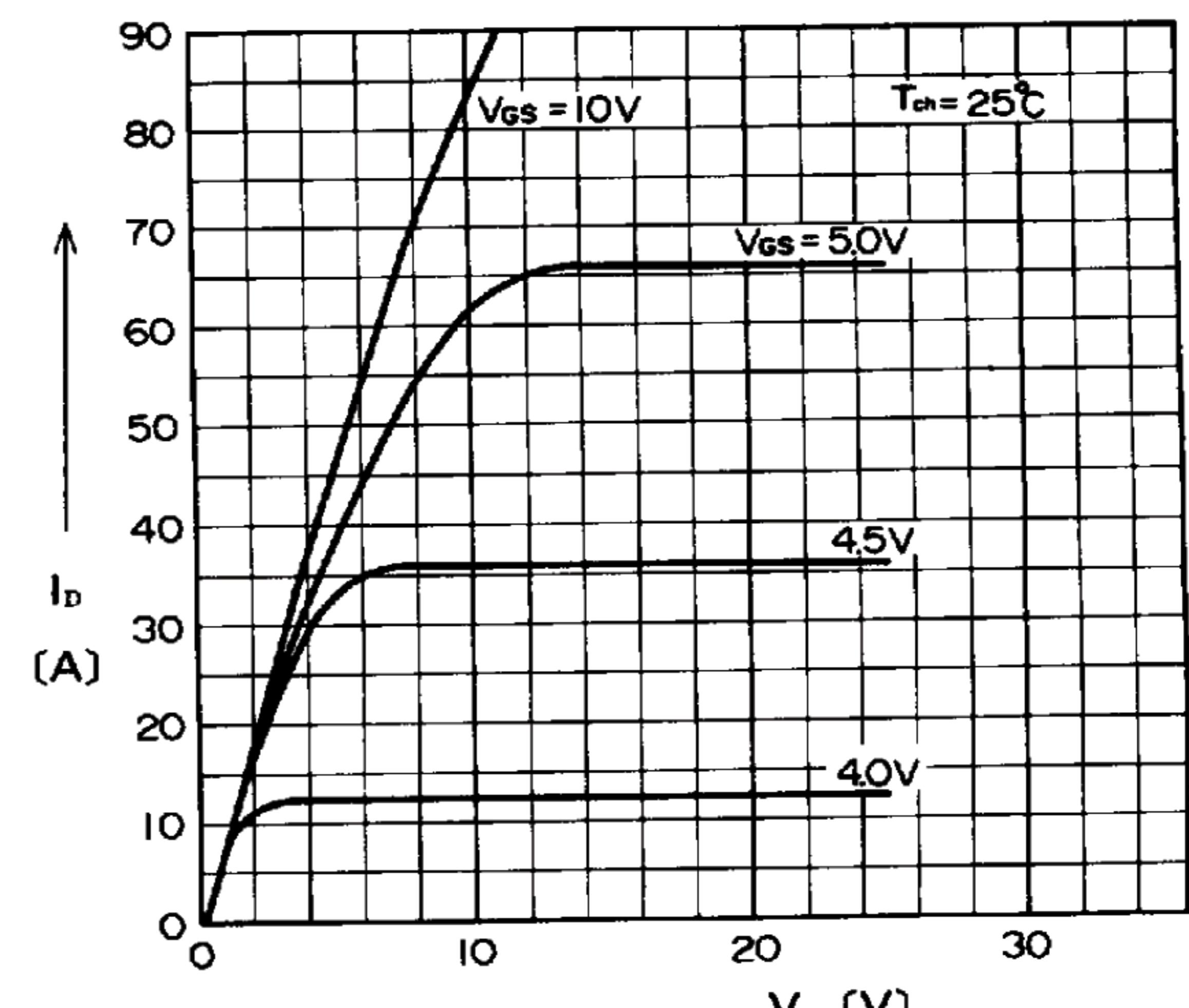
■ Equivalent Circuit Schematic



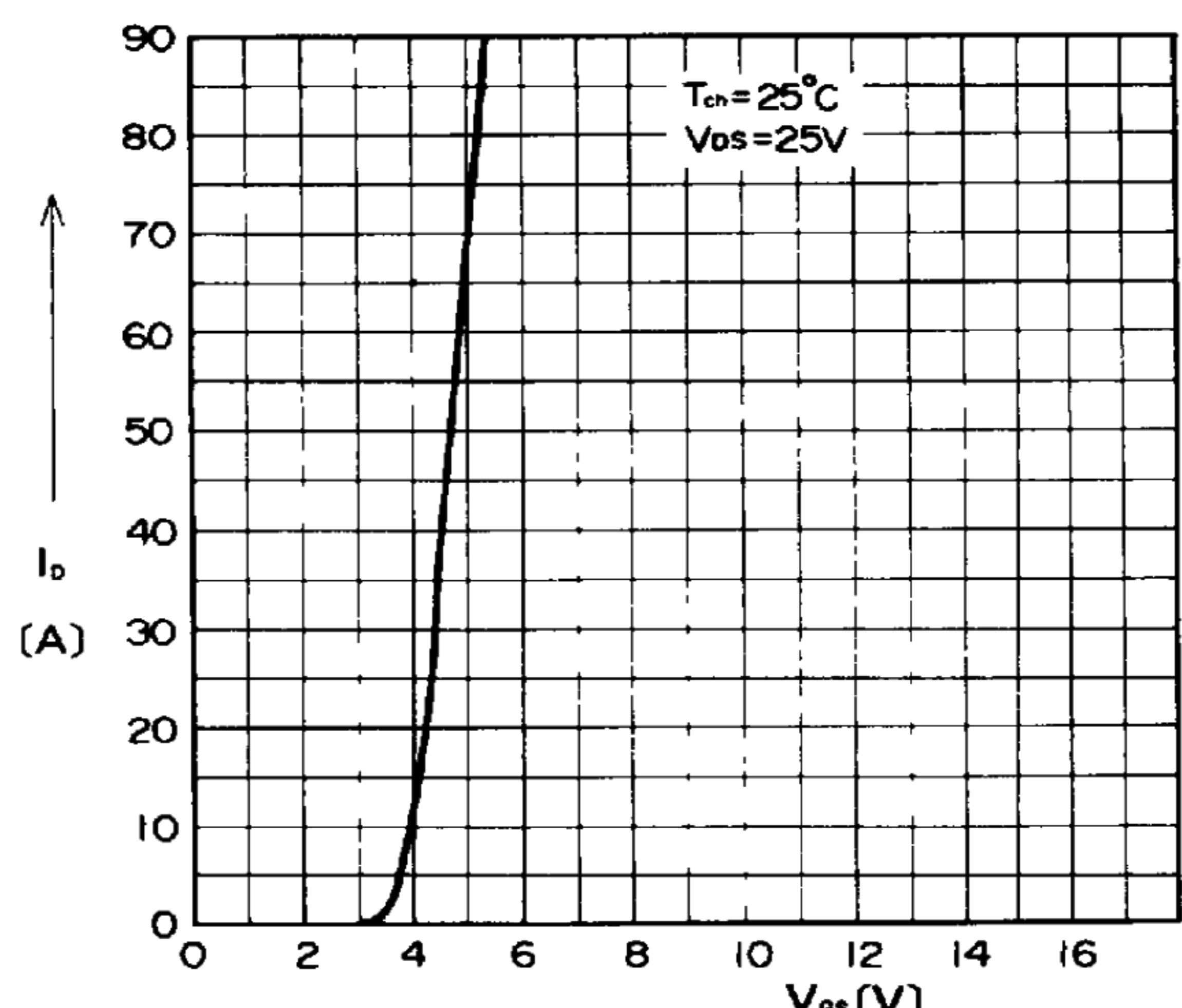
■ Characteristics



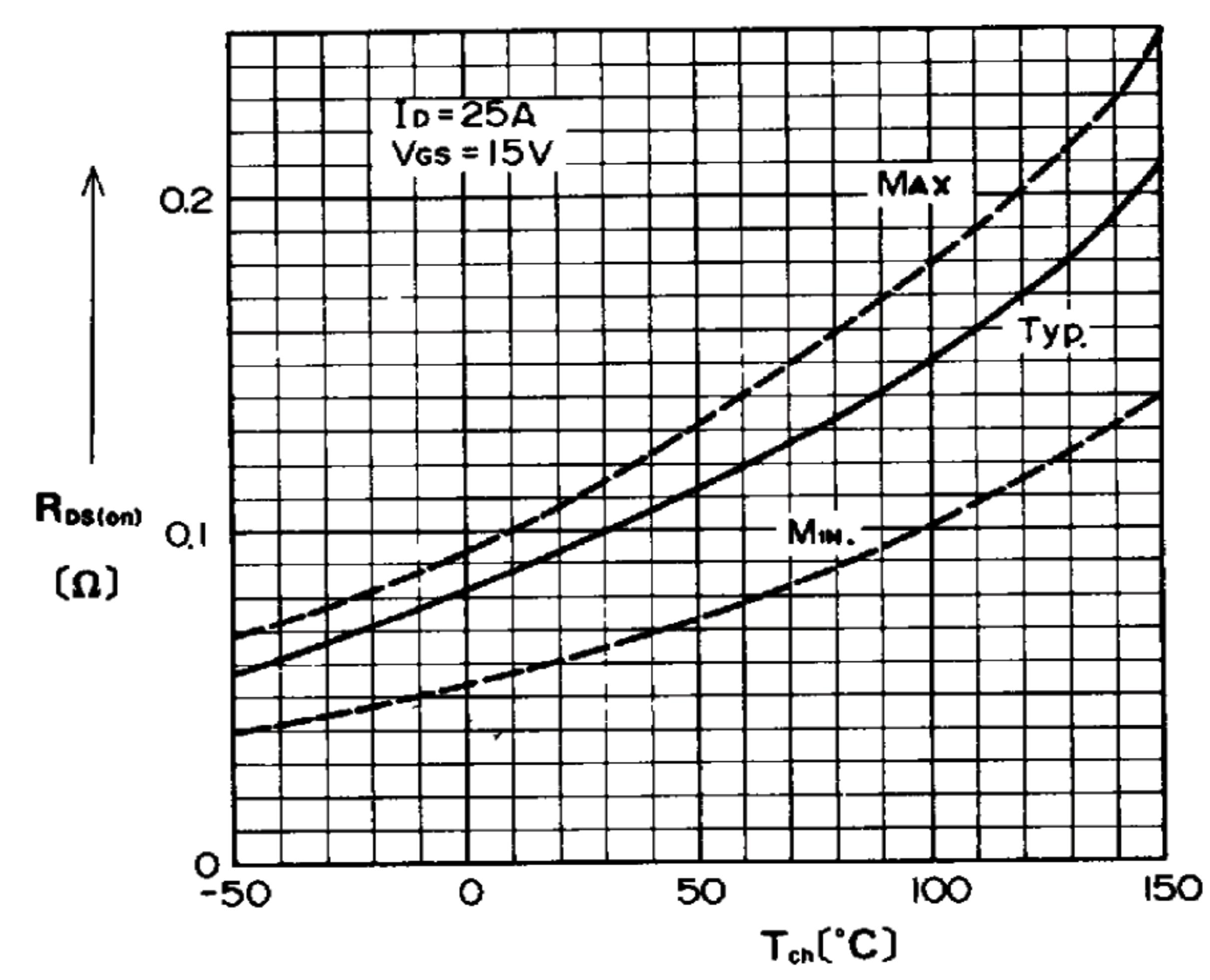
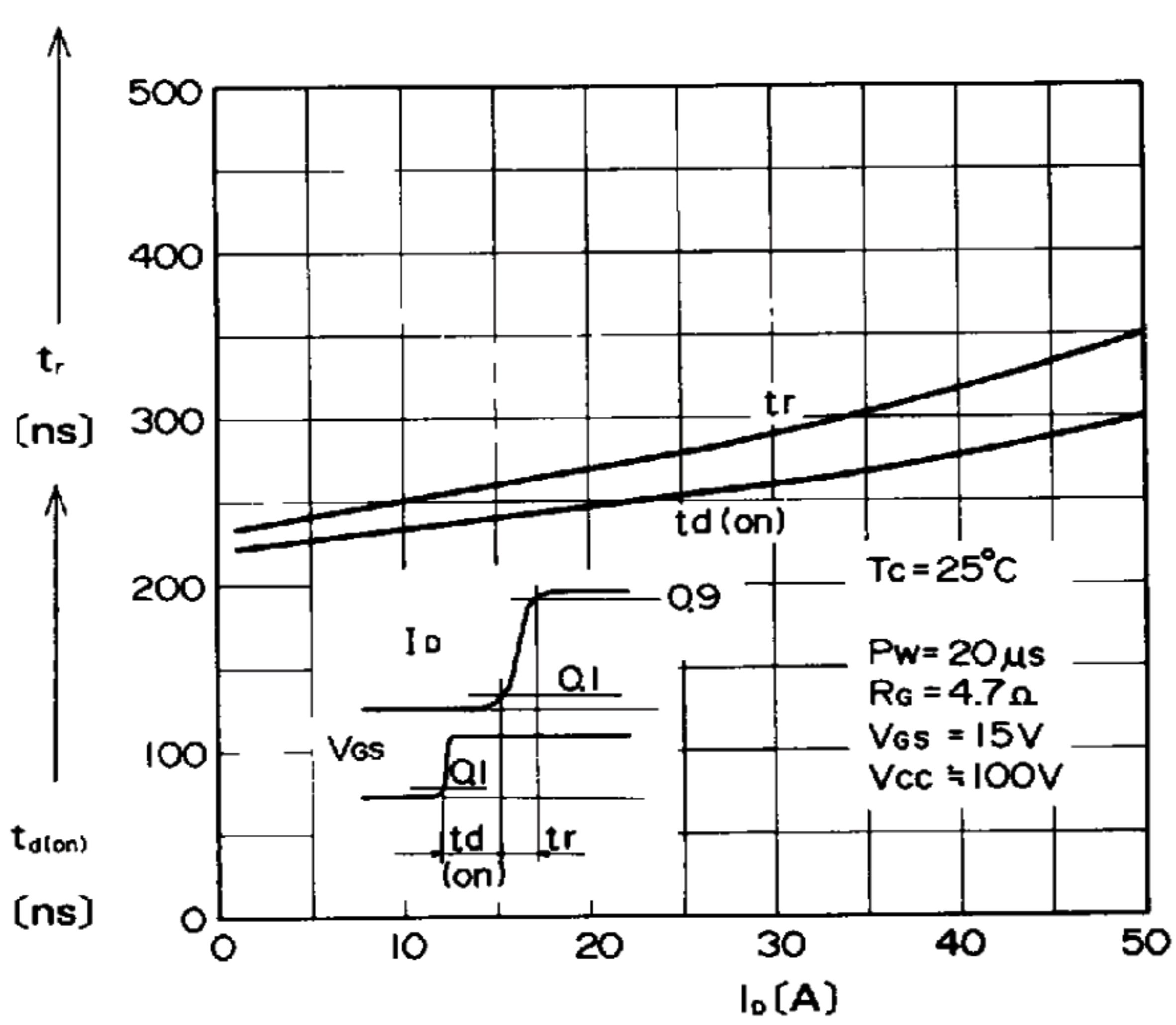
Current Duty Characteristics



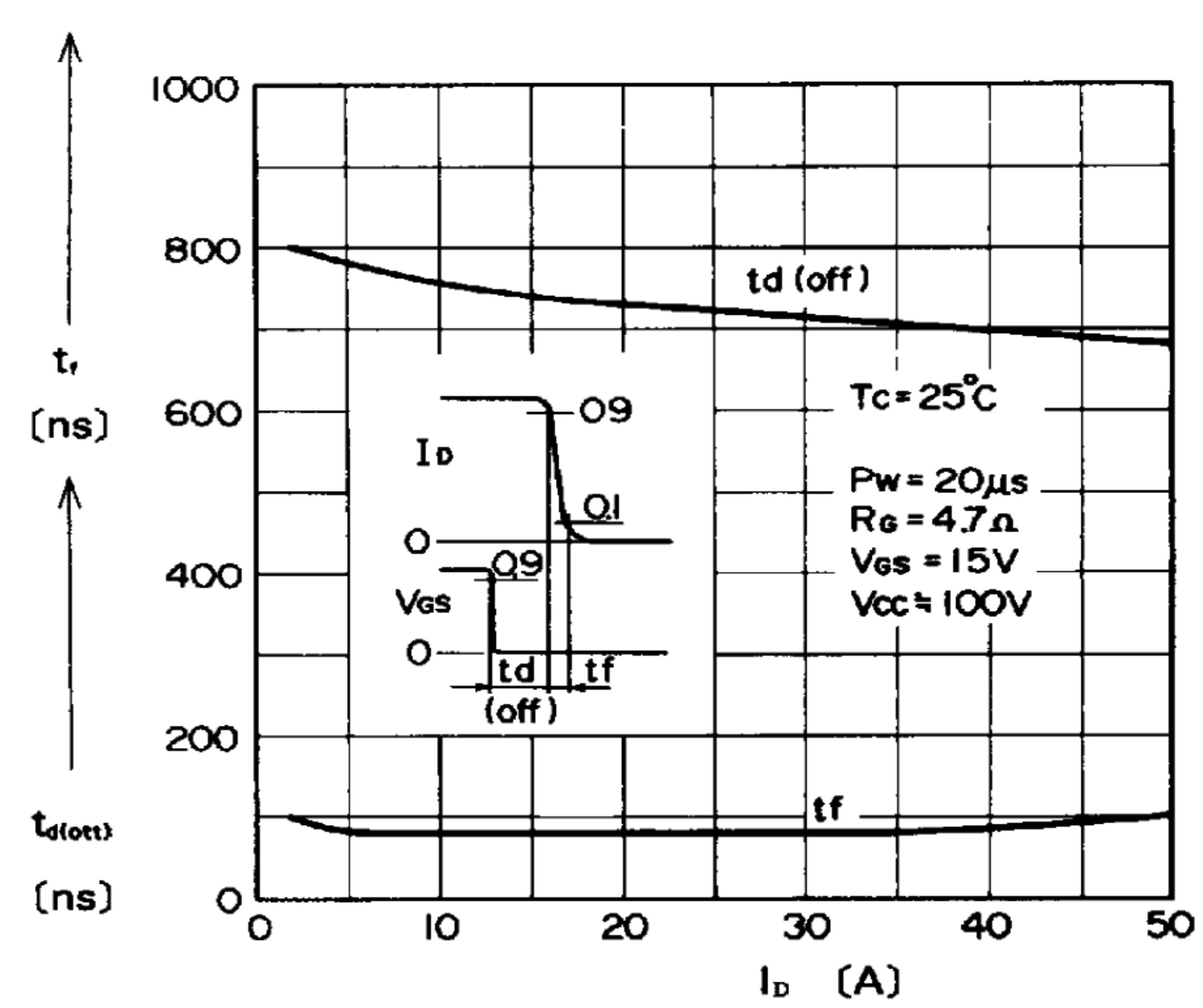
Typical Output Characteristics



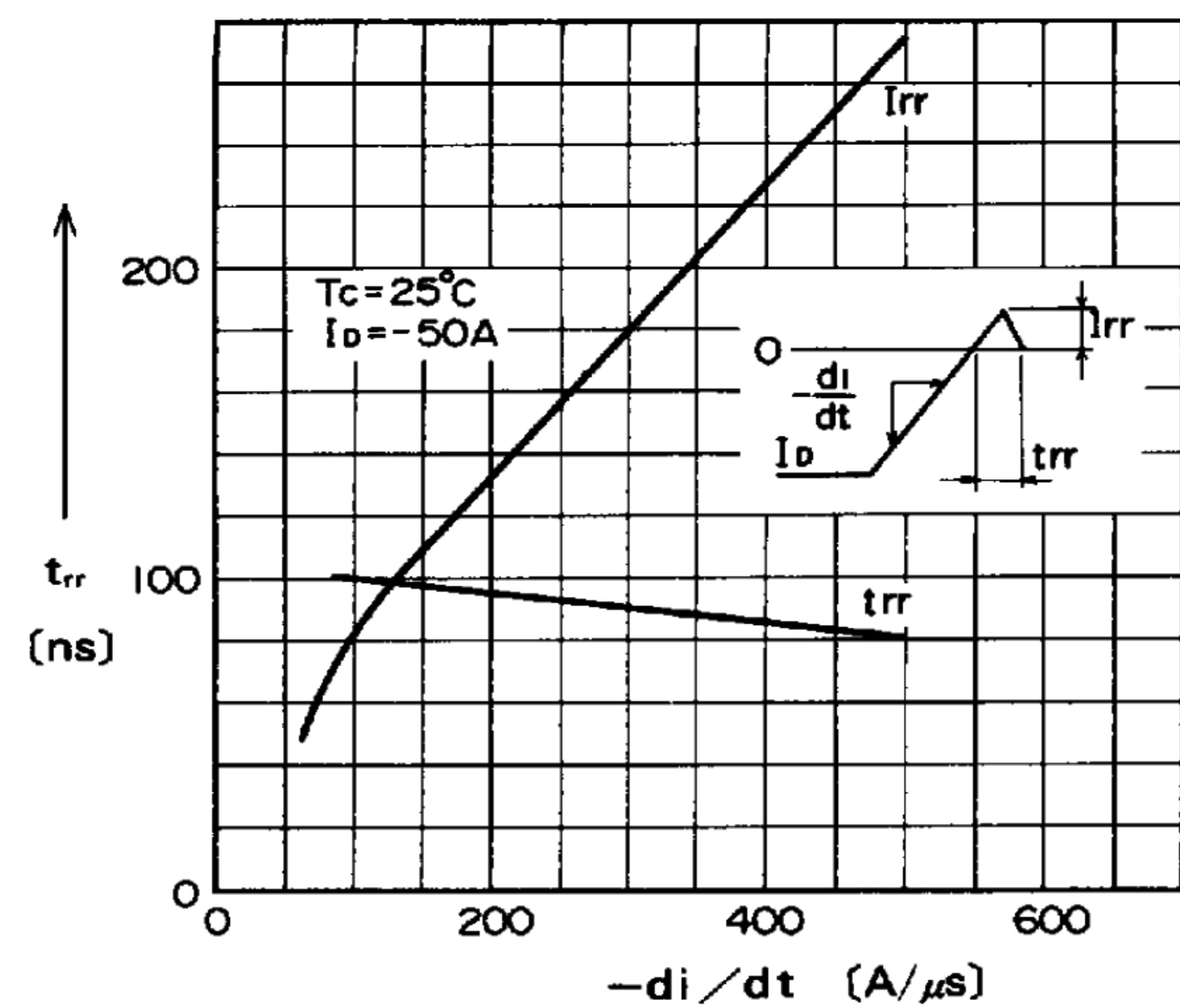
Typical Transfer Characteristics

 $R_{ds(on)}$ - T_{ch} Characteristics

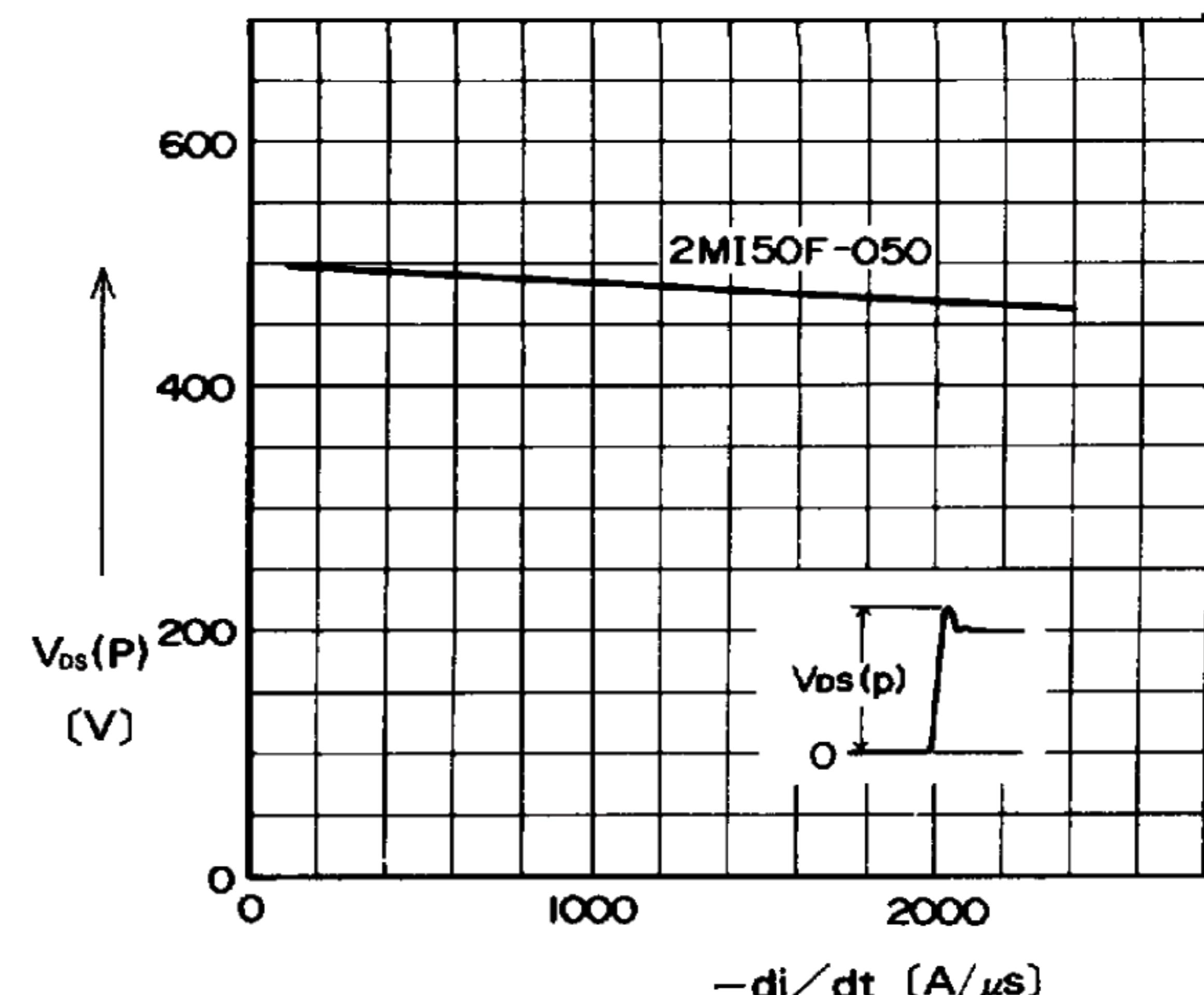
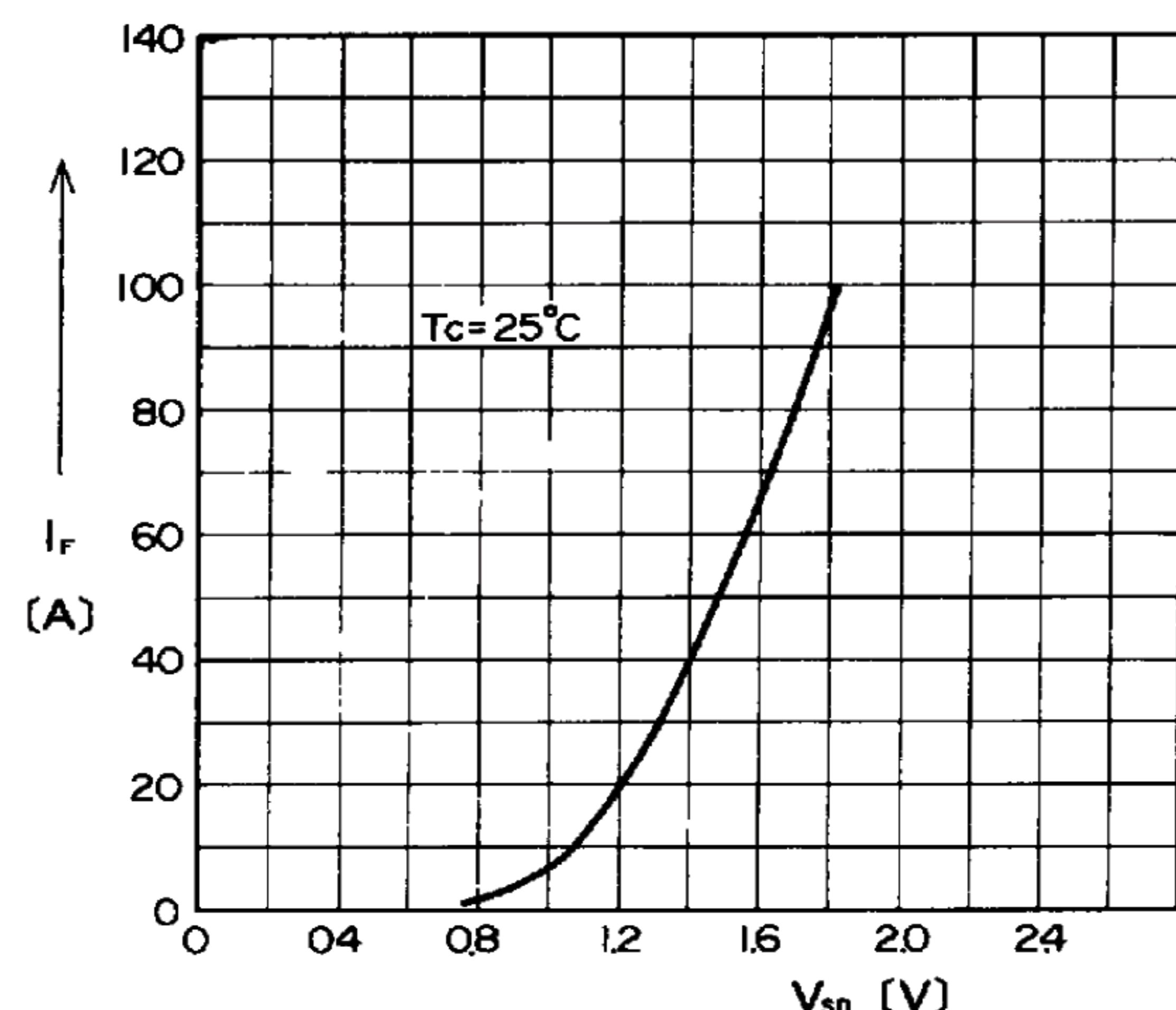
Turn-ON Characteristics



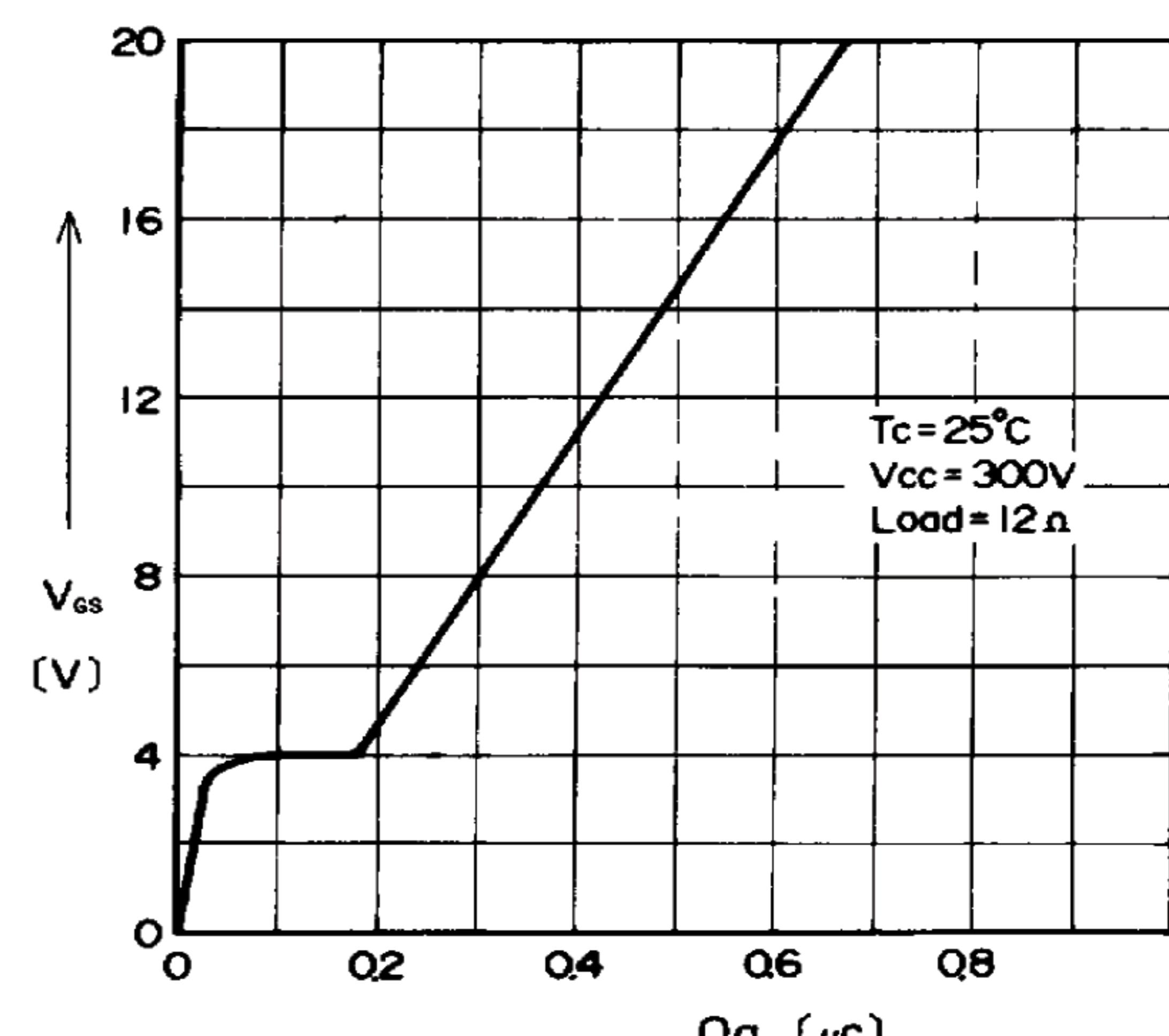
Turn-OFF Characteristics



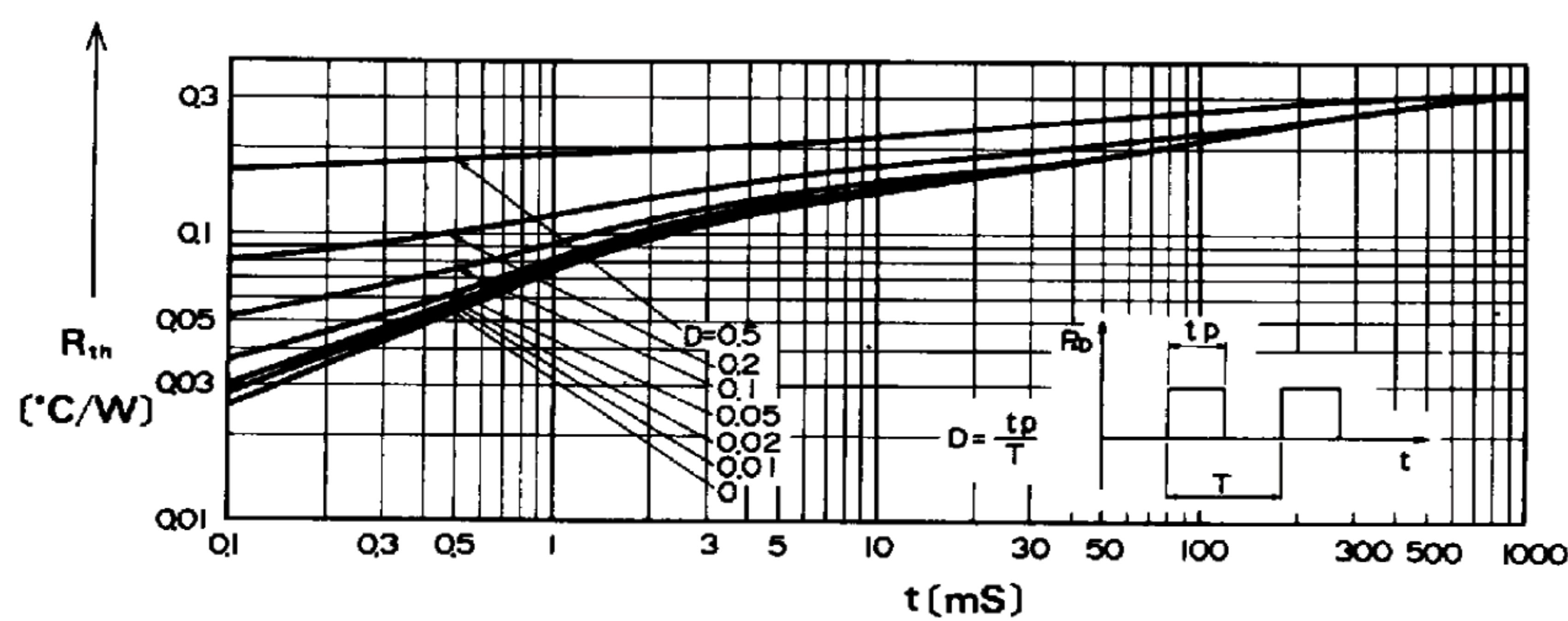
Reverse Recovery Characteristics

Max. Allowable di/dt at toff

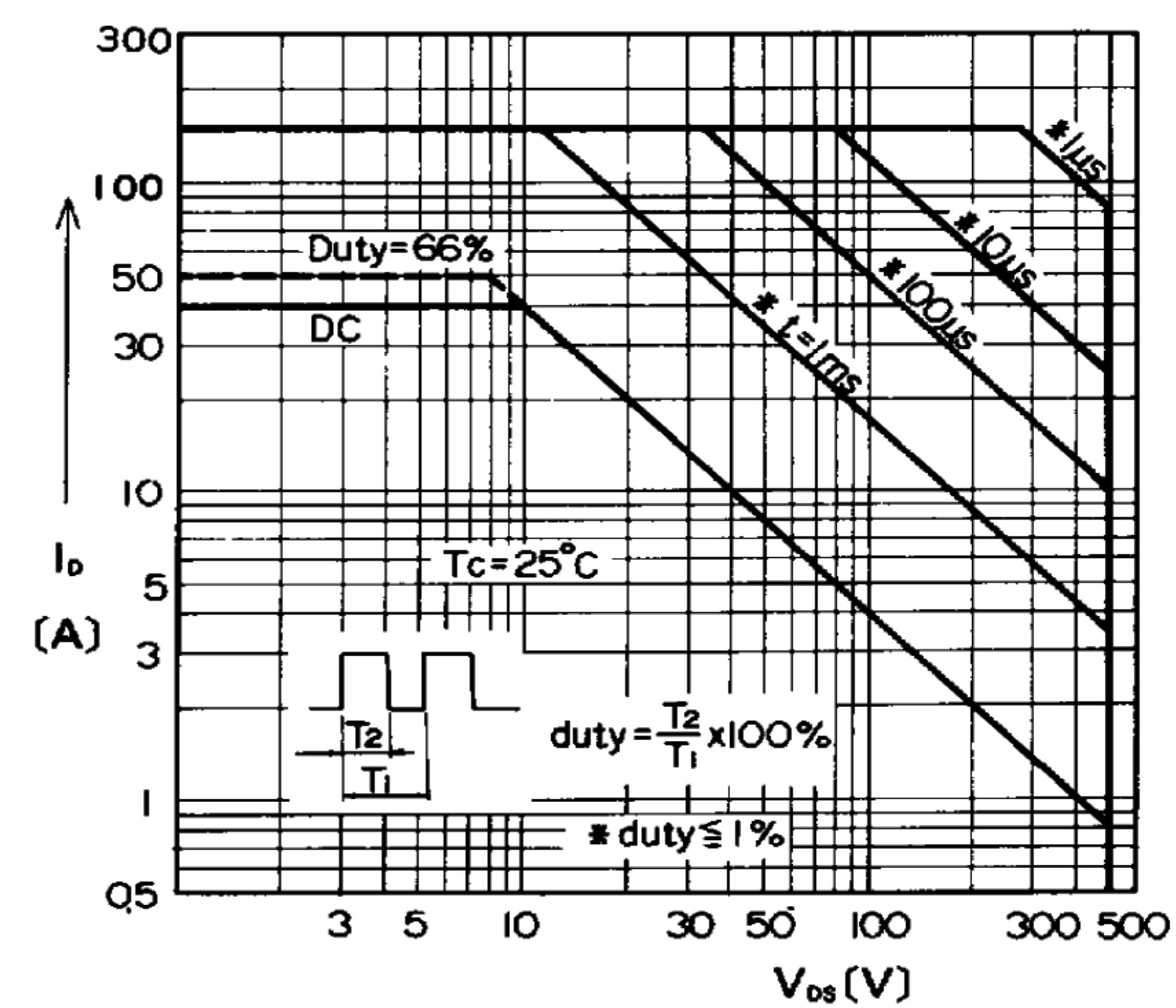
Forward Voltage of FWD



Typical Input Charge



Transient Thermal Impedance



Safe Operating Area